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Everlight Electronics Co Ltd 12-215/GHC-YR1S2/3C

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EVERLIGHT EVERLIGHT ELECTRONICS CO.,LTD.

Technical Data Sheet

Chip LED with Right Angle Lens

12-215/GHC-YR1S2/3C

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version

Descriptions

- The 12-215 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

David N.	Chip	E:44-1 C-1	Resin Color	
Part No.	Material	Emitted Color		
12-215/GHC-YR1S2/3C	InGaN	Brilliant Green	Water Clear	



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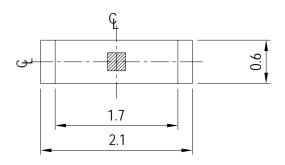
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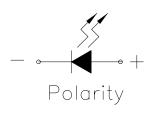


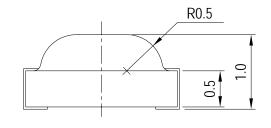


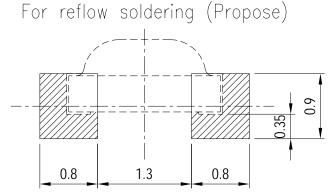
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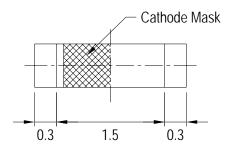
Package Outline Dimensions











Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd. Device No:SZDSE-125-G11

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Rev 2

Page: 2 of 10

Prepared date:6-Apr-2009 Prepared by: Huang yongxin





12-215/GHC-YR1S2/3C

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	I_{F}	25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	$ m I_{FP}$	100	mA	
Power Dissipation	P_d	95	mW	
Electrostatic Discharge(HBM)	ESD	150	V	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
Soldering Temperature	Tsol	Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Luminous Intensity	I_{V}	112		285	mcd		
Peak Wavelength	λp		518		nm		
Dominant Wavelength	λd	520		535	nm		
Spectrum Radiation Bandwidth	Δλ		35		nm	I _F =20mA	
Viewing Angle	$2 heta_{ ext{1/2}}$		130		deg		
Forward Voltage	V_{F}	2.7	3.3	3.7	V		
Reverse Current	I_R			50	μ A	$V_R=5V$	

Notes:

- 1. Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm

Everlight Electronics Co., Ltd.
Device No:SZDSE-125-G11

http://www.everlight.com

Rev 2

Page: 3 of 10

Prepared date:6-Apr-2009 Prepared by: Huang yongxin





12-215/GHC-YR1S2/3C

Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition
Y	X	520	525	nm	I _F =20mA
	Y	525	530		
	Z	530	535		

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition	
R1	112	140	mcd		
R2	140	180		I _F =20mA	
S1	180	225			
S2	225	285			

Notes:

- 1. Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm

Everlight Electronics Co., Ltd. Device No:SZDSE-125-G11

http://www.everlight.com Prepared date:6-Apr-2009

Rev 2

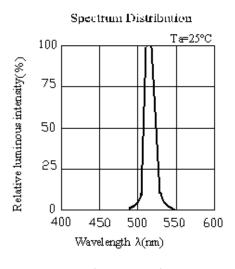
Page: 4 of 10

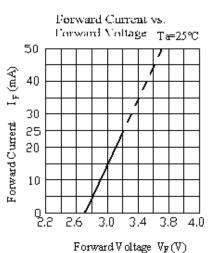




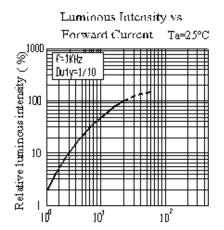
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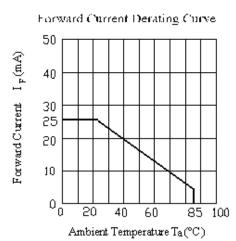
Electro-Optical Characteristics (Ta=25°C)

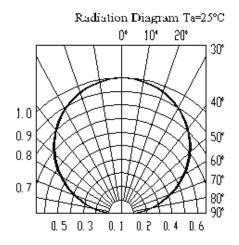




Ambient Temperature T_a(°C)







Forward Current Ir (mA)

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Rev 2

Page: 5 of 10

Device No:SZDSE-125-G11

Prepared date:6-Apr-2009





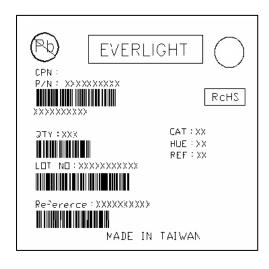
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Label explanation

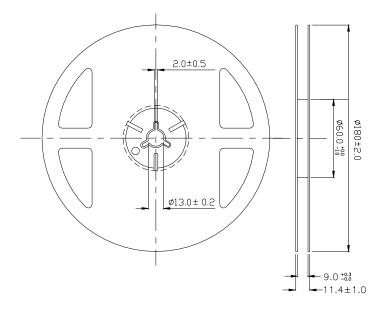
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd. Device No:SZDSE-125-G11

http://www.everlight.com

Rev 2

Page: 6 of 10

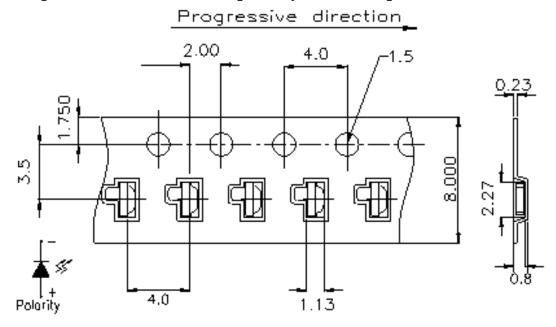
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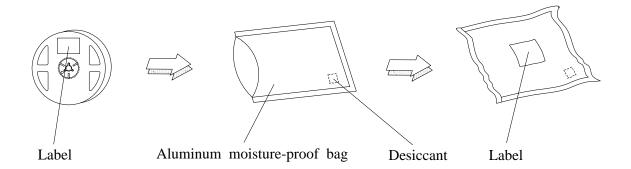
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Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



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Rev 2

Page: 7 of 10

Device No:SZDSE-125-G11

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12-215/GHC-YR1S2/3C

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85% RH	1000 Hrs.	22 PCS.	0/1

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12-215/GHC-YR1S2/3C

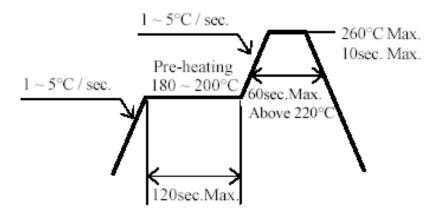
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
 - 2.3 After opening the package: The LED's floor life is 1 year under 30℃ or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
 - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.





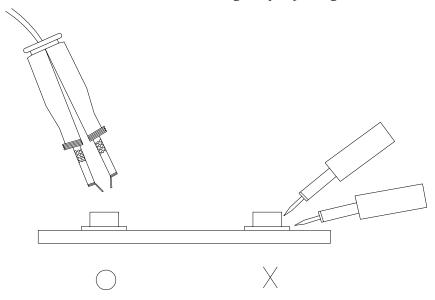
12-215/GHC-YR1S2/3C

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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Device No:SZDSE-125-G11 Prepared date:6-Apr

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